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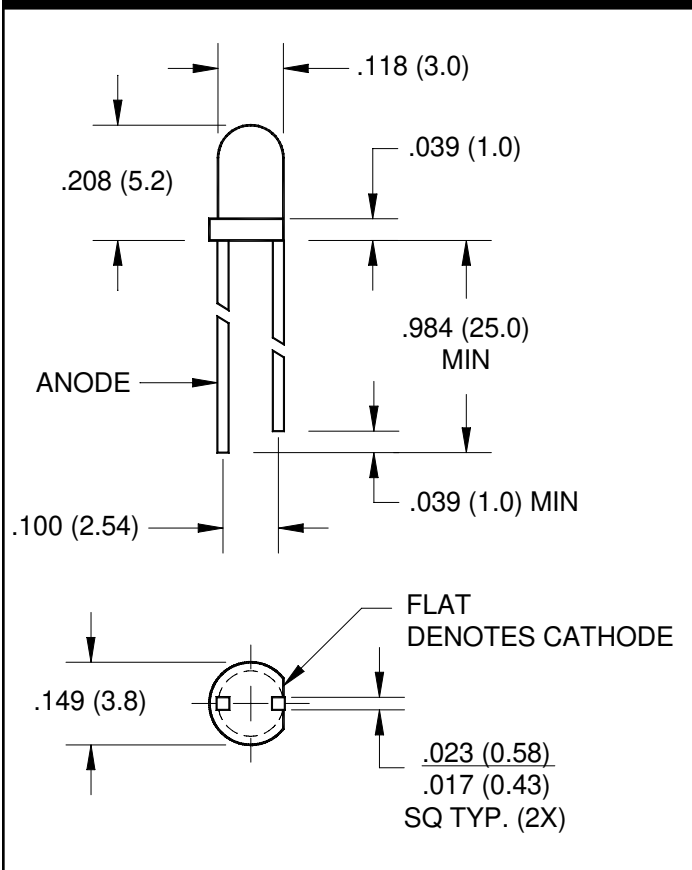
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



RED DIFFUSED QL202HD
 HER DIFFUSED QL202ID
 YELLOW DIFFUSED QL202YD
 GREEN DIFFUSED QL202GD

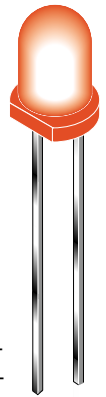
RED CLEAR QL202HT
 HER CLEAR QL202IT
 YELLOW CLEAR QL202YT
 GREEN CLEAR QL202GT

PACKAGE DIMENSIONS



FEATURES

- Popular T-100 package
- Choice of viewing angles
- Choice of tinted or tinted diffused lens



DESCRIPTION

These T-100 LEDs are used as general purpose indicators. They come in either a wide angle (70°) diffused lens or a moderate angle (32°) clear lens. The red and green lamps are made with GaP LEDs on a GaP substrate. The HER and yellow lamps are made with GaAsP LEDs on a GaP substrate. All have an epoxy encapsulation lens.

NOTES:

1. Dimensions for all drawings are in inches (mm).
2. Lead spacing is measured where the leads emerge from the package.
3. Protruded resin under the flange is 1.5 mm (0.059") max.
4. Tolerance is +/-0.12" (0.3mm) unless otherwise noted.

ABSOLUTE MAXIMUM RATING (T _A =25°C)						
Parameter	Symbol	Red	Her	Green	Yellow	Units
Power Dissipation	P _D	100	100	100	100	mA
Peak Forward Current (at f = 1.0 KHz, Duty factor = 1/10)	I _{FM}	50	100	100	100	mA
Reversed Voltage	V _R	5	5	5	5	V
Continuous DC Forward Current	I _F	15	20	20	20	mA
Lead Soldering Time at 260° C	T _{SOL}	5	5	5	5	sec
Operating Temperature	T _{OPR}	-40 to +100	-40 to +100	-40 to +100	-40 to +100	°C
Storage Temperature	T _{STG}	-40 to +100	-40 to +100	-40 to +100	-40 to +100	°C

ELECTRICAL / OPTICAL CHARACTERISTICS (T _A =25°C)						
Part Number	Symbol	QL202HD	QL202ID	QL202GD	QL202YD	Condition
Luminous Intensity (mcd)						I _F = 10mA
Minimum	I _V	0.5	1.1	1.1	1.1	
Typical		1.6	6.0	6.0	4.5	
Forward Voltage (V)						I _F = 10mA
Typical	V _F	1.7	1.7	1.7	1.7	
Maximum		2.1	2.0	2.1	2.0	
Spectral Line Half Width (nm)	Δλ	90	45	30	35	I _F = 10mA
Peak Wavelength (nm)	λ _p	697	635	565	585	I _F = 10mA
Viewing Angle (Total) (°)	2θ 1/2	70	70	70	70	I _F = 10mA

ELECTRICAL / OPTICAL CHARACTERISTICS (T _A =25°C)						
Part Number	Symbol	QL202HT	QL202IT	QL202GT	QL202YT	Condition
Luminous Intensity (mcd)						I _F = 10mA
Minimum	I _V	2.5	3.5	3.0	3.5	
Typical		10.0	17.0	15.0	15.0	
Forward Voltage (V)						I _F = 10mA
Typical	V _F	1.7	1.7	1.7	1.7	
Maximum		2.1	2.0	2.1	2.0	
Spectral Line Half Width (nm)	Δλ	90	45	30	35	I _F = 10mA
Peak Wavelength (nm)	λ _p	697	635	565	585	I _F = 10mA
Viewing Angle (Total) (°)	2θ 1/2	32	32	32	32	I _F = 10mA

1. The leads of the device were immersed in molten solder at 260°C, to a point 1/16 inch (1.6 mm) from the body of the device per MIL-S-750, with a dwell time of 5 seconds.

TYPICAL PERFORMANCE CURVES ($T_A = 25^\circ\text{C}$)

Fig. 1 Forward Current vs. Forward Voltage

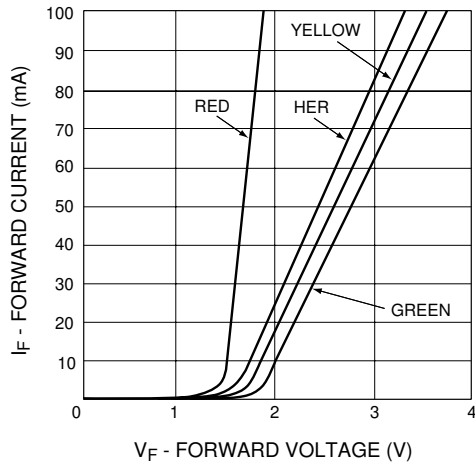


Fig. 2 Luminous Intensity vs. Forward Current

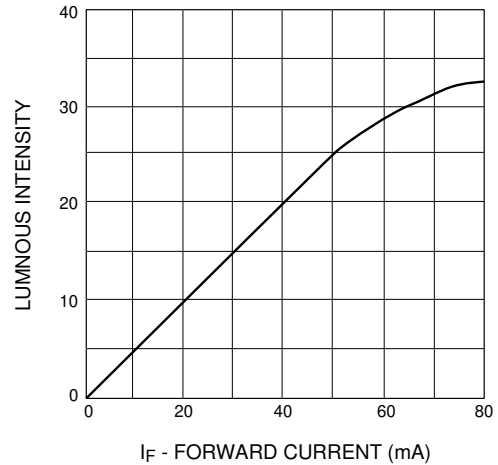


Fig. 3 Spatial Distribution

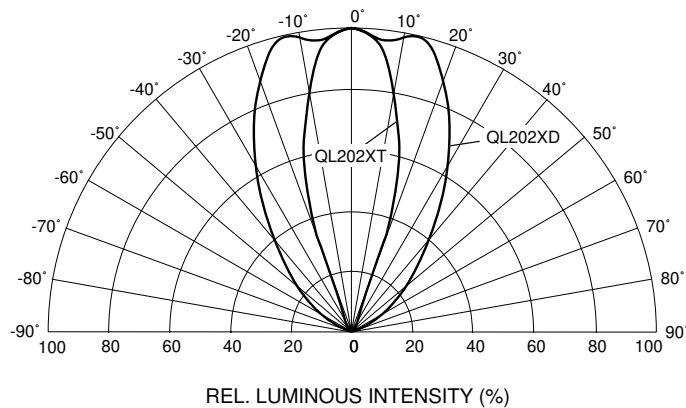
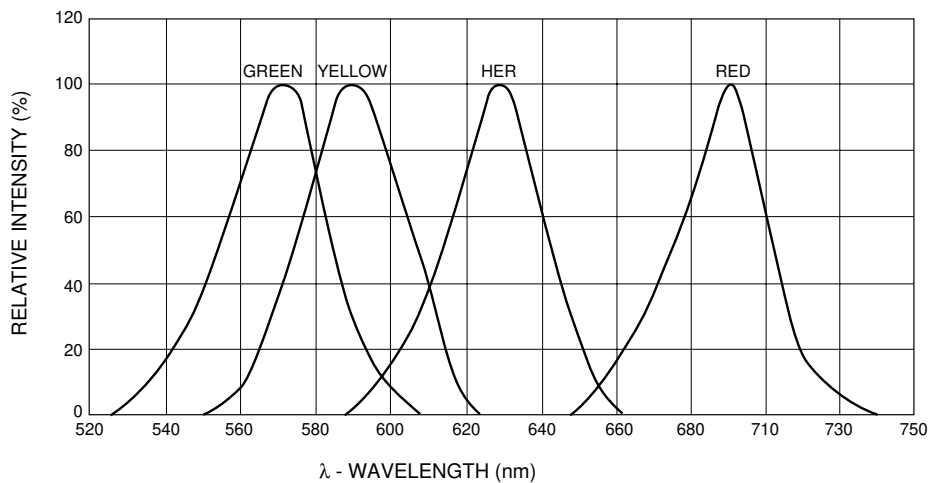


Fig. 4 Relative Intensity vs. Peak Wavelength



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